

**Amendments to the Claims:**

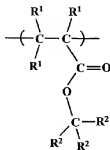
This listing of claims will replace all prior versions and listings of claims in the application.

**Listing of Claims:**

1. (Currently Amended) A radiation-sensitive resin composition comprising an acid-labile group-containing resin which is insoluble or scarcely soluble in alkali, but becomes alkali soluble by the action of an acid, and

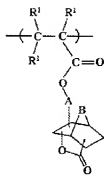
a photoacid generator,

wherein the acid-labile group-containing resin comprises a recurring unit of the following formula (1) and at least one recurring unit selected from the group consisting of the recurring units of the following formulas (2)-(7), wherein the resin [[and]] has a ratio of a weight average molecular weight to a number average molecular weight (weight average molecular weight/number average molecular weight) of ~~smaller~~ less than 1.5, wherein the resin ~~and~~ is polymerized with a living radical polymerization initiator such that the resin is a random copolymer of the recurring units which form the resin and wherein the content of the recurring unit (1) is 15-70 mol% of the total amount of the recurring units in the resin.

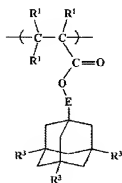


(1)

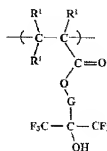
wherein  $R^1$  individually represents a hydrogen atom, methyl group, trifluoromethyl group, or hydroxymethyl group and  $R^2$  individually represents a monovalent alicyclic hydrocarbon group having 4-20 carbon atoms or a derivative thereof, or a linear or branched alkyl group having 1-4 carbon atoms, in which at least one of  $R^2$  groups is a monovalent alicyclic hydrocarbon group or a derivative thereof, or any two of  $R^2$  groups form a divalent alicyclic hydrocarbon group having 4-20 carbon atoms or a derivative thereof in combination with the carbon atom to which the two  $R^2$  groups bond, with the remaining  $R^2$  group being a linear or branched alkyl group having 1-4 carbon atoms or a monovalent alicyclic hydrocarbon group having 4-20 carbon atoms or a derivative thereof,



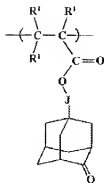
(2)



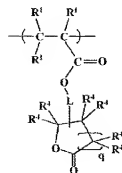
(3)



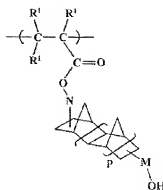
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(5)



(6)



(7)

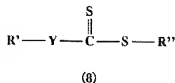
wherein R<sup>1</sup> individually represents a hydrogen atom, methyl group, trifluoromethyl group, or hydroxymethyl group, A represents a single bond, a substituted or unsubstituted, linear or branched alkylene group having 1-6 carbon atoms, a mono- or dialkylene glycol group, or an alkylene ester group, B represents a single bond, a substituted or unsubstituted alkylene group having 1-3 carbon atoms, an alkyloxy group, or an oxygen atom, E represents a single bond or a divalent alkyl group having 1-3 carbon atoms, R<sup>2</sup> individually represents a hydroxyl group, cyano group, carboxyl group, -COOR<sup>5</sup>, or -Y-R<sup>6</sup>, wherein R<sup>5</sup> represents a hydrogen atom, a linear or a branched alkyl group having 1-4 carbon atoms, or an alicyclic alkyl group having 3-20 carbon atoms, Y individually represents a single bond or a divalent alkylene group having 1-3 carbon atoms, R<sup>6</sup> individually represents a hydrogen atom, hydroxyl group, cyano group, or -COOR<sup>7</sup>, provided that at least one R<sup>3</sup> group is not a hydrogen atom, R<sup>7</sup> represents a hydrogen atom, a linear or branched alkyl group having 1-4 carbon atoms, or an alicyclic alkyl group having 3-20 carbon atoms, G represents a single bond, a linear or branched alkylene group having 1-6 carbon atoms, an alicyclic hydrocarbon group having 4-20 carbon atoms, an alkylene glycol group, or an alkylene ester group, J, L, N, and M individually represent a single bond, a substituted or unsubstituted, linear, branched, or cyclic alkylene group having 1-20 carbon atoms, an alkylene glycol group, or an alkylene ester group, p is 0 or 1, R<sup>4</sup> represents a hydrogen atom, a linear or branched alkyl group having 1-4 carbon atoms, an alkoxy group, a hydroxyalkyl group, or a divalent alicyclic hydrocarbon group having 3-20 carbon atoms or a derivative thereof, and q is 1 or 2.

3. (Currently Amended) The radiation-sensitive resin composition of ~~claim 2~~  
Claim 1, wherein the acid-labile group-containing resin comprises a recurring unit of the  
formula (2).

4-5. (Cancel).

6. (Original) The radiation-sensitive resin composition according to claim 1,  
wherein the living radical polymerization initiator is a mixture of a transition metal  
complex, an organic halide, and a Lewis acid or an amine.

7. (Original) The radiation-sensitive resin composition according to claim  
1, wherein the living radical polymerization initiator is a compound of the  
following formula (8),



wherein R' represents an alkyl group or an aryl group having 1-15 carbon atoms which  
may contain an ester group, ether group, amino group, or amide group; Y represents a  
single bond, oxygen atom, nitrogen atom, or sulfur atom; and R'' represents an alkyl  
group or an aryl group having 1-15 carbon atoms which may contain an ester group, ether  
group, or amino group.

8. (Previously Presented) The radiation-sensitive resin composition according to  
Claim 6, wherein terminal processing of the living radical polymerization initiator is  
conducted using a heat radical generator.

9. (Original) The radiation-sensitive resin composition according to claim 1, wherein the photoacid generator comprises at least one compound selected from the group consisting of a triphenylsulfonium salt compound, a 4-cyclohexylphenyldiphenylsulfonium salt compound, a 4-t-butylphenyldiphenylsulfonium salt compound, and a tri( 4-t-butylphenyl)sulfonium salt compound.

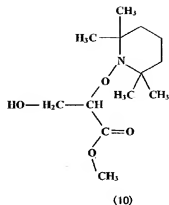
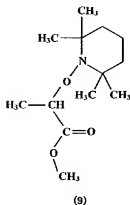
10. (Original) The radiation-sensitive resin composition according to claim 1, further comprising a nitrogen-containing organic compound as an acid diffusion controller.

11. (Cancel).

12. (Previously Presented) The radiation-sensitive resin composition according to Claim 7, wherein terminal processing of the living radical polymerization initiator is conducted using a heat radical generator.

13. (Previously Presented) The radiation-sensitive resin composition according to Claim 1, wherein the acid-labile group-containing resin has a ratio of a weight average molecular weight to a number average molecular weight (weight average molecular weight/number average molecular weight) of 1.0 to 1.3.

14. (Previously Presented) The radiation-sensitive resin composition according to Claim 1, wherein the living radical polymerization initiator is a compound of the following formula (9) or (10):



15. (Withdrawn) A method comprising:  
 depositing a composition as set forth in Claim 1 onto a substrate to form a resist film;  
 selectively exposing the resist film to radiation to form an exposed resist film; and  
 developing the exposed resist film to form a resist pattern.
16. (Withdrawn) The method of Claim 15, wherein the radiation is ArF excimer laser radiation.
17. (Withdrawn) The method of Claim 15, further comprising heating the exposed resist film prior to developing.
18. (Withdrawn) The method of Claim 17, wherein the exposed resist film is heated to a temperature of 30 to 200° C prior to developing.
19. (Withdrawn) The method of Claim 18, wherein the exposed resist film is heated to a temperature of 50 to 170° C prior to developing.
20. (Withdrawn) The method of Claim 15, further comprising heating the resist film prior to selectively exposing.